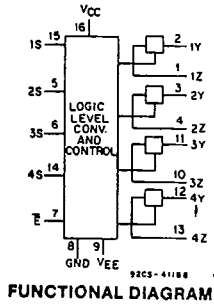


High-Speed CMOS Logic

T-51-11-00



Quad Analog Switch with Level Translation

- Type Features:**
- Wide analog-input-voltage range ($V_{CC}-V_{EE}$): 0-10 V
 - Low "ON" resistance: 45 Ω typ. @ $V_{CC}=4.5$ V
35 Ω typ. @ $V_{CC}=6$ V
30 Ω typ. @ $V_{CC}-V_{EE}=9$ V
 - Fast switching and propagation delay times
 - Low "OFF" leakage current
 - Built-in "Break-before-make" switching
 - Logic-level translation to enable 5 V logic to accommodate ± 5 V analog signals

The RCA CD54/74HC/HCT4316 contains four independent digitally controlled analog switches that use silicon-gate CMOS technology to achieve operating speeds similar to LSTTL with the low power consumption of standard CMOS integrated circuits.

In addition these devices contain logic-level translation circuits that provide for analog signal switching of voltages between ± 5 V via 5 V logic. Each switch is turned on by a high-level voltage on its select input (S) when the common Enable (E) is Low. A High E disables all switches. The digital inputs can swing between V_{CC} and Gnd; the analog inputs/outputs can swing between V_{CC} as a positive limit and V_{EE} as a negative limit. Voltage ranges are shown in Figs. 2 and 3.

- Family Features:**
- Wide operating temperature range:
CD74HC/HCT: -40 to +125°C
 - CD54HC/CD74HC types:
2 V to 10 V operation
High noise immunity:
 $N_{IL} = 30\%$, $N_{IH} = 30\%$ of V_{CC} ; @ $V_{CC} = 5$ V
 - CD54HCT/CD74HCT types:
Direct LSTTL input logic compatibility
 $V_{IL} = 0.8$ V max., $V_{IH} = 2$ V min.
CMOS input compatibility
 $I_i \leq 1 \mu A$ @ V_{OL} , V_{OH}
 - Alternate Source is Phillips/Sigmetics

The CD54HC4316 and CD54HCT4316 are supplied in 16-lead hermetic dual-in-line ceramic packages (F suffix). The CD74HC4316 and CD74HCT4316 are supplied in 16-lead dual-in-line plastic packages (E suffix) and in 16-lead dual-in-line surface-mount plastic packages (M suffix). Both types are also available in chip form (H suffix).

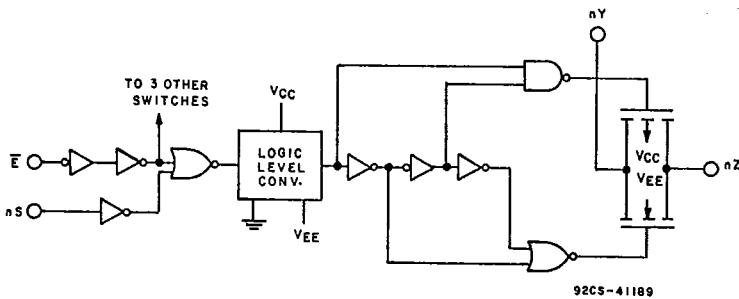


Fig. 1 - Logic diagram (one switch).

TRUTH TABLE

INPUTS		SWITCH
E	S	
L	L	OFF
L	H	ON
H	X	OFF

H = High Level Voltage
L = Low Level Voltage
X = Don't Care

CD54/74HC4316
CD54/74HCT4316

MAXIMUM RATINGS, Absolute-Maximum Values: (All voltages referenced to Gnd unless otherwise shown)

DC SUPPLY-VOLTAGE ($V_{CC}-V_{EE}$)	-0.5 to +10.5 V
DC SUPPLY-VOLTAGE (V_{CC})	-0.5 to +7 V
DC SUPPLY-VOLTAGE (V_{EE})	+0.5 to -7 V
DC INPUT DIODE CURRENT, I_{IK} (FOR $V_i < -0.5$ V OR $V_i > V_{CC} + 0.5$ V)	± 20 mA
DC SWITCH DIODE CURRENT, I_{OK} (FOR $V_i < V_{EE} - 0.5$ V OR $V_i > V_{CC} + 0.5$ V)	± 20 mA
DC SWITCH CURRENT (FOR $V_i > V_{EE} - 0.5$ V OR $V_i < V_{CC} + 0.5$ V)	+25 mA
DC V_{CC} OR GROUND CURRENT (I_{CC})	± 50 mA
DC V_{EE} CURRENT (I_{EE})	-20 mA
POWER DISSIPATION PER PACKAGE (P_D):	
For $T_A = -40$ to $+100^\circ\text{C}$ (PACKAGE TYPE E)	500 mW
For $T_A = +100$ to $+125^\circ\text{C}$ (PACKAGE TYPE E)	Derate Linearly at 8 mW/ $^\circ\text{C}$ to 300 mW
For $T_A = -55$ to $+100^\circ\text{C}$ (PACKAGE TYPE F, H)	500 mW
For $T_A = +100$ to $+125^\circ\text{C}$ (PACKAGE TYPE F, H)	Derate Linearly at 8 mW/ $^\circ\text{C}$ to 300 mW
For $T_A = -40$ to $+70^\circ\text{C}$ (PACKAGE TYPE M)	400 mW
For $T_A = +70$ to $+125^\circ\text{C}$ (PACKAGE TYPE M)	Derate Linearly at 6 mW/ $^\circ\text{C}$ to 70 mW
OPERATING-TEMPERATURE RANGE (T_A):	
PACKAGE TYPE F, H	-55 to $+125^\circ\text{C}$
PACKAGE TYPE E, M	-40 to $+125^\circ\text{C}$
STORAGE TEMPERATURE (T_{STG})	-65 to $+150^\circ\text{C}$
LEAD TEMPERATURE (DURING SOLDERING):	
At distance $1/16 \pm 1/32$ in. (1.59 ± 0.79 mm) from case for 10 s max.	$+265^\circ\text{C}$
Unit inserted into a PC Board (min. thickness $1/16$ in., 1.59 mm) with solder contacting lead tips only	$+300^\circ\text{C}$

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIMITS		UNITS
	MIN.	MAX.	
Supply-Voltage Range (For T_A =Full Package-Temperature Range) V_{CC} .*	2	6	V
CD54/74HC Types	4.5	5.5	
Supply-Voltage Range (For T_A =Full Package-Temperature Range) $V_{CC}-V_{EE}$	2	10	V
Supply-Voltage Range (For T_A =Full Package-Temperature Range) V_{EE} .*	0	-6	V
DC Input Control Voltage, V_i	Gnd	V_{CC}	V
Analog Switch I/O Voltage, V_{IS}	V_{EE}	V_{CC}	V
Operating Temperature, T_A :			$^\circ\text{C}$
CD74 Types	-40	+125	
CD54 Types	-55	+125	
Input Rise and Fall Times, t_r, t_f :			ns
at 2 V	0	1000	
at 4.5 V	0	500	
at 6 V	0	400	

*Unless otherwise specified, all voltages are referenced to Ground.

Recommended Operating Area as a Function of Supply Voltages

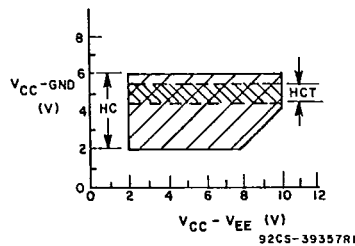


Fig. 2

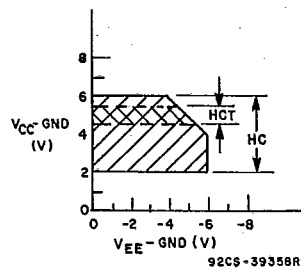


Fig. 3

HARRIS SEMICONDUCTOR 27E D 430227J 0010127 9 HAS

HARRIS SEMICONDUCTOR 27E D 430227J 0018J28 0 HAS

T-51-11

New Data

CD54/74HC4316
CD54/74HCT4316

STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	TEST CONDITIONS				74HC/54HC		74HC	54HC -55/ +125°C	TEST CONDITIONS				74HCT/54HCT		74HCT	54HCT -55/ +125°C	UNITS													
	V _{IS} V	V _I V	V _{EE} V	V _{CC} V	+25°C			-40/ +85°C	74HC -40/ +125°C			V _{IS} V	V _I V	V _{EE} V	V _{CC} V	+25°C			-40/ +85°C	74HCT -40/ +125°C										
					Min	Typ	Max	Min	Max	Min	Max					Min		Typ	Max	Min	Max	Min	Max							
High-Level Input Voltage V _{HI}					2	1.5	—	—	1.5	—	1.5	—					4.5	to	2	—	—	2	—	2	—	V				
Low-Level Input Voltage V _{LI}					2	—	—	0.5	—	0.5	—	0.5					4.5	to	—	—	0.8	—	0.8	—	0.8	V				
"On" Resistance R _{on} (Fig. 4 & 5)	V _{CC} or V _{EE}	V _L or V _{HI}	0	4.5	—	45	180	—	225	—	270	Same as HC	Same as HC	0	4.5	—	45	180	—	225	—	270	Ω							
			0	8	—	35	160	—	200	—	240			—	—	—	—	—	—	—	—	—		—						
	V _{CC} to V _{EE}	0	4.5	—	30	135	—	170	—	205	—			—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	Ω
		0	4.5	—	85	320	—	400	—	480	—			—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	Ω
Maximum "On" Resistance between any two channels ΔR _{on}					0	4.5	—	10	—	—	—	—					0	4.5	—	10	—	—	—	—	—	—	Ω			
Switch Off Leakage Current I _{LZ}	V _{CC} -V _{EE}	V _L or V _{HI}	0	8	—	—	±0.1	—	±1	—	±1						0	8	—	—	±0.1	—	±1	—	±1	—	μA			
Control Input Leakage Current I _L	—	V _{CC} or Gnd	0	8	—	—	±0.1	—	±1	—	±1						5.5	—	—	±0.1	—	±1	—	±1	—	μA				
Quiescent Device Current I _{CC} I _O = 0	When V _{IS} = V _{EE} , V _{OE} = V _{CC} , When V _{IS} = V _{CC} , V _{OE} = V _{EE}	V _{CC} or Gnd	0	8	—	—	8	—	80	—	160	Same as HC	Same as HC	0	5.5	—	—	8	—	80	—	160	μA							
			-5	5	—	—	16	—	160	—	320			-4.5	5.5	—	—	16	—	160	—	320								
Additional Quiescent Current per input pin: 1 unit load ΔI _{CC} *														V _{CC} -2.1	4.5	to	—	100	360	—	450	—	490	—	μA					

*For dual-supply systems theoretical worst case (V_I = 2.4 V, V_{CC} = 5.5 V) specification is 1.8 mA.
**Any voltage between V_{CC} and Gnd.

HCT Input Loading Table

Input	Unit Loads*
All	0.5

*Unit Load is ΔI_{CC} limit specified in Static Characteristics Chart, e.g., 360 μA max. @ 25°C.

T-51-11

CD54/74HC4316
CD54/74HCT4316

SWITCHING CHARACTERISTICS (V_{CC}=5 V, T_A=25° C, Input t_r,t_f=6 ns)

CHARACTERISTIC	C _L (pF)	TYPICAL VALUES		UNITS
		HC	HCT	
Turn "ON" Time E to Out nS to Out	15	17	18	ns
		14	17	
Turn "ON" Time E to Out nS to Out	15	17	24	
		14	18	
Turn "OFF" Time E to Out nS to Out	15	17	21	
		14	18	
Power Dissipation Capacitance*	—	42	47	pF

*C_{PD} is used to determine the dynamic power consumption, per package.

$$P_D = C_{PD} V_{CC}^2 f_i + \sum (C_L + C_s) V_{CC}^2 f_o$$

f_i = input frequency

f_o = output frequency

C_L = output load capacitance

C_s = switch capacitance

V_{CC} = supply voltage.

SWITCHING CHARACTERISTICS (C_L=50 pF, Input t_r,t_f=6 ns)

CHARACTERISTIC	V _{EE}	V _{CC}	LIMITS												UNITS
			25° C				-40° C to +85° C				-55° C to +125° C				
			HC		HCT		74HC		74HCT		54HC		54HCT		
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
Propagation Delay Switch In to Out	0	2	—	60	—	—	—	75	—	—	—	90	—	—	ns
			0	4.5	—	12	—	12	—	15	—	15	—	18	
			0	6	—	10	—	—	—	13	—	—	—	15	
Turn "ON" Time E to Out	-4.5	4.5	—	8	—	8	—	10	—	10	—	12	—	12	
			0	2	—	205	—	—	—	255	—	—	—	310	
			0	4.5	—	41	—	44	—	51	—	55	—	62	
	0	6	—	35	—	—	—	43	—	—	—	53			
	t _{PZL}	-4.5	4.5	—	37	—	42	—	47	—	53	—	56	—	63
				0	2	—	205	—	—	—	255	—	—	—	310
0				4.5	—	41	—	56	—	51	—	70	—	62	
Turn "ON" Time nS to Out	-4.5	4.5	—	34	—	34	—	43	—	43	—	51	—	51	
			0	2	—	175	—	—	—	220	—	—	—	265	
			0	4.5	—	35	—	40	—	44	—	53	—	53	
	0	6	—	30	—	—	—	37	—	—	—	45			
	t _{PZL}	-4.5	4.5	—	34	—	34	—	43	—	43	—	51	—	51
				0	2	—	175	—	—	—	220	—	—	—	265
0				4.5	—	35	—	50	—	44	—	63	—	53	
Turn "OFF" Time E to Out	-4.5	4.5	—	37	—	46	—	47	—	58	—	56	—	69	
			0	2	—	205	—	—	—	255	—	—	—	310	
			0	4.5	—	41	—	50	—	51	—	63	—	62	
	0	6	—	35	—	—	—	43	—	—	—	53			
	t _{PLZ}	-4.5	4.5	—	37	—	46	—	47	—	58	—	56	—	69
				0	2	—	175	—	—	—	220	—	—	—	265
0				4.5	—	35	—	44	—	44	—	55	—	53	
Turn "OFF" Time nS to Out	-4.5	4.5	—	34	—	40	—	43	—	50	—	51	—	60	
			0	2	—	175	—	—	—	220	—	—	—	265	
			0	4.5	—	35	—	44	—	44	—	55	—	53	
	0	6	—	30	—	—	—	37	—	—	—	45			
	C _I	—	—	—	10	—	10	—	10	—	10	—	10	—	10
				0	2	—	175	—	—	—	220	—	—	—	265
0				4.5	—	35	—	44	—	44	—	55	—	53	

HARRIS SEMICONDUCTOR SECTOR 27E D 43022271 0018129 2 HAS

CD54/74HC4316
CD54/74HCT4316

ANALOG CHANNEL CHARACTERISTICS - Typical Values at $T_A = 25^\circ\text{C}$

CHARACTERISTIC	TEST CONDITIONS	V_{CC} V	HC	HCT	UNITS
Switch Frequency Response Bandwidth at -3 dB (Fig. 15)	Fig. 6 Notes 1 and 2	4.5	>200	>200	MHz
Crosstalk Between Any Two Switches (Fig. 16)	Fig. 7 Notes 2 and 3	4.5	TBE	TBE	dB
Total Harmonic Distortion	1 kHz, Fig. 8	$V_{IS}=4 V_{PP}$	0.078	0.078	%
		$V_{IS}=8 V_{PP}$	0.018	0.018	
Control to Switch Feedthrough Noise	Fig. 9	4.5	TBE	TBE	mV
		9	TBE	TBE	
Switch "OFF" Signal Feedthrough (Fig. 16)	Fig. 10 Notes 2 and 3	4.5	-62	-62	dB
Switch Input Capacitance C_s	—	—	5	5	pF

Notes:

1. Adjust input level for 0 dBm at output, $f = 1$ MHz.
2. V_{IS} is centered at $V_{CC}/2$.
3. Adjust input for 0 dBm at V_{IS} .

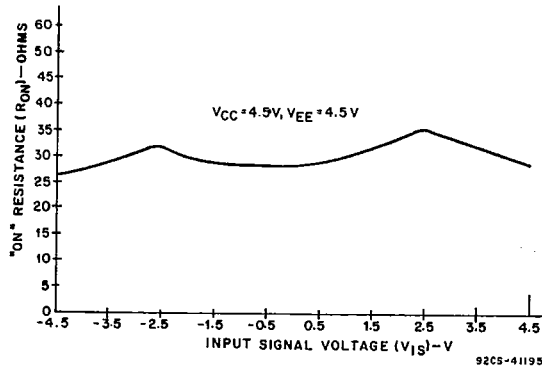


Fig. 4 - Typical "ON" resistance vs. input signal voltage.

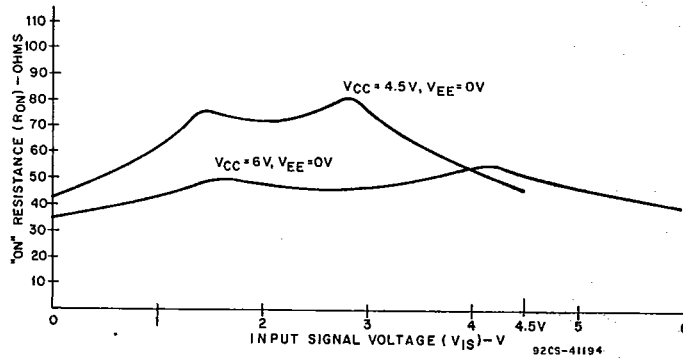


Fig. 5 - Typical "ON" resistance vs. input signal voltage.

CD54/74HC4316
CD54/74HCT4316

HARRIS SEMICONDUCTOR 27E D 430227J 001813J 0 HAS

ANALOG TEST CIRCUITS

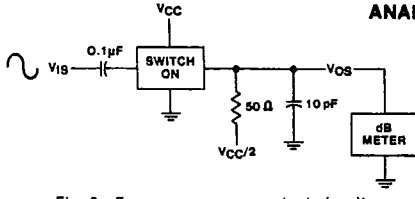


Fig. 6 - Frequency response test circuit.

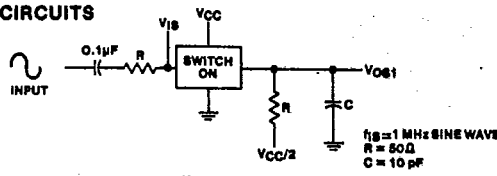


Fig. 7 - Crosstalk between two switches test circuit.

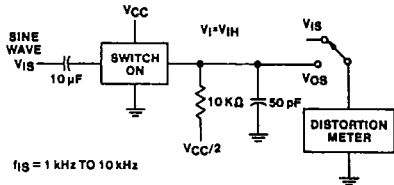


Fig. 8 - Total harmonic distortion test circuit.

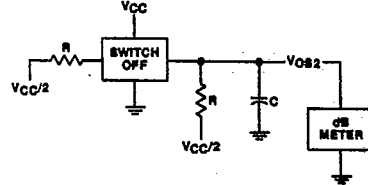


Fig. 9 - Control-to-switch feedthrough noise test circuit.

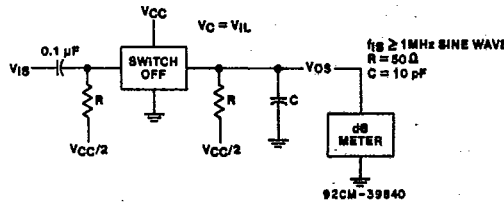


Fig. 10 - Switch off signal feedthrough.

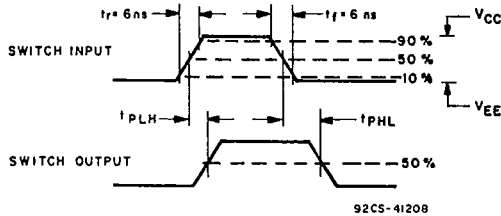


Fig. 11 - Switch propagation - delay times waveforms.

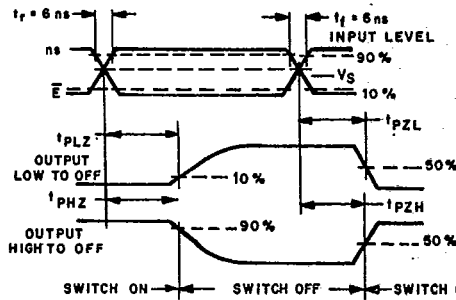


Fig. 12 - Switch turn-on and turn-off propagation delay times waveforms.

	54/74HC	54/74HCT
Input Level	V _{CC}	3 V
Switching Voltage, V _S	50% V _{CC}	1.3 V

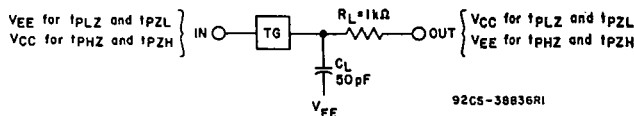


Fig. 13 - Switch on/off propagation delay time test circuit.

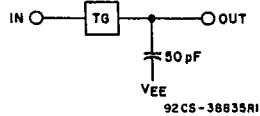


Fig. 14 - Switch-in to switch-out propagation delay time test circuit.

CD54/74HC4316
CD54/74HCT4316

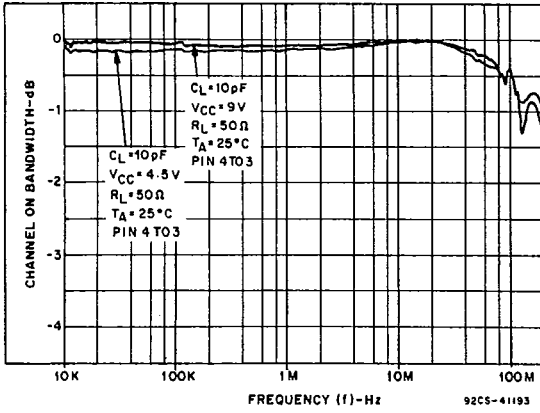


Fig. 15 - Switch frequency response.

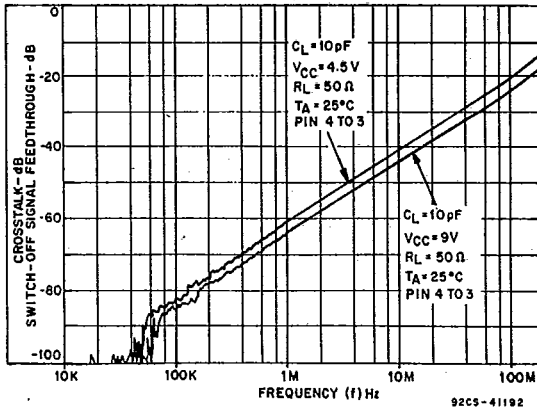


Fig. 16 - Switch-off signal feedthrough and crosstalk vs. frequency.